

TECHNICAL SPECIFICATION



**Process management for avionics – Counterfeit prevention –
Part 1: Avoiding the use of counterfeit, fraudulent and recycled electronic
components**



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**PROCESS MANAGEMENT FOR AVIONICS –
COUNTERFEIT PREVENTION –****Part 1: Avoiding the use of counterfeit, fraudulent
and recycled electronic components**

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Technical specifications are subject to review within three years of publication to decide whether they can be transformed into International Standards.

IEC/TS 62668-1, which is a technical specification, has been prepared by IEC technical committee 107: Process management for avionics.

This second edition cancels and replaces the first edition, published in 2012. This edition constitutes a technical revision.

This edition includes the following significant technical changes with respect to the previous edition:

- a) Update of “fraudulent component” definition, addition of “recycled component” and “suspect component” definitions, and updates of the concerned clauses accordingly.
- b) Addition of counterfeit awareness training as a requirement.
- c) Revision to update all references and web links in the annexes.

The text of this technical specification is based on the following documents:

Enquiry draft	Report on voting
107/226/DTS	107/235/RVC

Full information on the voting for the approval of this technical specification can be found in the report on voting indicated in the above table.

This publication has been drafted in accordance with the ISO/IEC Directives, Part 2.

A list of all the parts in the IEC 62668 series, published under the general title *Process management for avionics – Counterfeit prevention*, can be found on the IEC website.

The committee has decided that the contents of this publication will remain unchanged until the stability date indicated on the IEC web site under "<http://webstore.iec.ch>" in the data related to the specific publication. At this date, the publication will be

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